

Title (en)  
BINDER RESIN, VEHICLE COMPOSITION, AND PASTE COMPOSITION HAVING INORGANIC MICROPARTICLE DISPERSED THEREIN

Title (de)  
BINDEMITTELHARZ, VEHIKELZUSAMMENSETZUNG UND PASTENZUSAMMENSETZUNG MIT DARIN DISPERGIERTEM ANORGANISCHEM MIKROPARTIKEL

Title (fr)  
RÉSINE LIANTE, COMPOSITION DE VÉHICULE ET COMPOSITION DE PÂTE AYANT DES MICROPARTICULES INORGANIQUES DISPERSÉES DANS CELLE-CI

Publication  
**EP 2204391 A1 20100707 (EN)**

Application  
**EP 08829729 A 20080905**

Priority  
• JP 2008066109 W 20080905  
• JP 2007233141 A 20070907

Abstract (en)  
It is an object of the present invention to provide a binder resin which, when used in an inorganic fine particle-dispersed paste composition, leaves little amount of residual carbon after sintering and can be degreased even under low temperature conditions. It is also an object of the present invention to provide a vehicle composition and an inorganic fine particle-dispersed paste composition, which are obtained by using the binder resin. The binder resin of the present invention is for use in an inorganic fine particle-dispersed paste composition containing inorganic fine particles. The binder resin contains from 5 to 55% by weight of a segment derived from methyl methacrylate, from 30 to 80% by weight of a segment derived from isobutyl methacrylate, and from 5 to 20% by weight of a segment derived from polyoxyalkylene ether monomethacrylate.

IPC 8 full level  
**C08F 220/10** (2006.01); **C08F 290/06** (2006.01); **C08K 3/00** (2006.01); **C08L 33/04** (2006.01)

CPC (source: EP US)  
**C08F 220/1804** (2020.02 - EP US); **C08L 33/10** (2013.01 - EP US); **C08L 33/12** (2013.01 - EP US); **C09J 133/14** (2013.01 - EP US); **C08F 220/14** (2013.01 - EP US); **C08F 220/287** (2020.02 - EP US); **C08L 1/02** (2013.01 - EP US)

Cited by  
US11649308B2; EP3643746A4

Designated contracting state (EPC)  
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MT NL NO PL PT RO SE SI SK TR

Designated extension state (EPC)  
AL BA MK RS

DOCDB simple family (publication)  
**EP 2204391 A1 20100707**; **EP 2204391 A4 20111019**; **EP 2204391 B1 20140101**; CN 101796087 A 20100804; CN 101796087 B 20121031; JP 4269000 B2 20090527; JP WO2009031663 A1 20101216; KR 101513753 B1 20150420; KR 20100065275 A 20100616; US 2010222462 A1 20100902; US 8680189 B2 20140325; WO 2009031663 A1 20090312

DOCDB simple family (application)  
**EP 08829729 A 20080905**; CN 200880105263 A 20080905; JP 2008066109 W 20080905; JP 2008542546 A 20080905; KR 20107002985 A 20080905; US 73350208 A 20080905